



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Ronald Redline et al.

APR 02 2001

Atty. Docket No.: 2156-056A

Serial No.: 09/698,370

Group Art Unit: 1741

Filed: October 26, 2000

Title: Method for Enhancing the Solderability of a Surface

1741
SAH
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4-S-01

Nicholas

Hon. Commissioner of Patents and Trademarks
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

Pursuant to Sections 609 and 707.05(b) of the MPEP and 37 CFR 1.97-1.99, a copy is herewith submitted of documents that may be pertinent to the invention as claimed in the above-identified application. The attached form PTO-1449 lists these documents individually.

As this Information Disclosure Statement is being filed before the mailing date of a first Office action on the merits, no fee is believed due. However, in the event that a fee is due, please charge Deposit Account No.: 50-0447 to cover these fees. The citation of these documents should not be construed as a representation that a thorough search has been made, or that other, more pertinent material is not available.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited this date with the United States Postal Service as first class mail in an envelope addressed to:

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Date: March 30, 2001

By:

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Respectfully submitted,

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